

# MC33275, NCV33275

## 300 mA, Low Dropout Voltage Regulator

The MC33275 series are micropower low dropout voltage regulators available in a wide variety of output voltages as well as packages, SOT-223, SOP-8, DPAK, and DFN 4x4 surface mount packages. These devices feature a very low quiescent current and are capable of supplying output currents up to 300 mA. Internal current and thermal limiting protection are provided by the presence of a short circuit at the output and an internal thermal shutdown circuit.

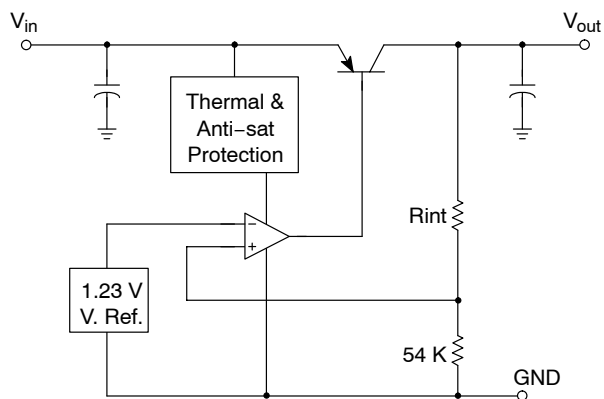
Due to the low input-to-output voltage differential and bias current specifications, these devices are ideally suited for battery powered computer, consumer, and industrial equipment where an extension of useful battery life is desirable.

### Features

- Low Input-to-Output Voltage Differential of 25 mV at  $I_O = 10$  mA, and 260 mV at  $I_O = 300$  mA
- Extremely Tight Line and Load Regulation
- Stable with Output Capacitance of only 0.33  $\mu$ F for 2.5 V Output Voltage
- Internal Current and Thermal Limiting
- NCV Prefix for Automotive and Other Applications Requiring Site and Control Changes
- Pb-Free Packages are Available

### Applications

- Battery Powered Consumer Products
- Hand-Held Instruments
- Camcorders and Cameras



This device contains 41 active transistors

Figure 1. Simplified Block Diagram

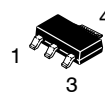


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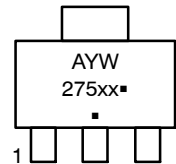
<http://onsemi.com>

## LOW DROPOUT MICROPOWER VOLTAGE REGULATOR

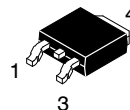
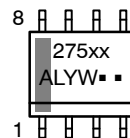
### MARKING DIAGRAMS



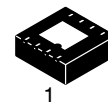
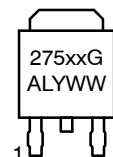
SOT-223  
ST SUFFIX  
CASE 318E



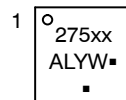
SOIC-8  
D SUFFIX  
CASE 751



DPAK-3  
DT SUFFIX  
CASE 369A



DFN-8, 4x4  
MN SUFFIX  
CASE 488AF



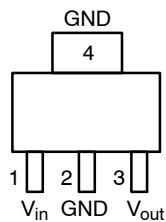
xx = Voltage Version  
A = Assembly Location  
L = Wafer Lot  
Y = Year  
W, WW = Work Week  
▪ or G = Pb-Free Device  
(Note: Microdot may be in either location)

### ORDERING INFORMATION

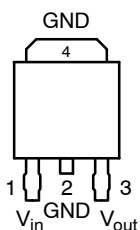
See detailed ordering and shipping information in the package dimensions section on page 10 of this data sheet.

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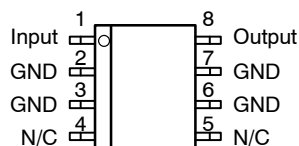
## PIN CONNECTIONS



MC33275ST

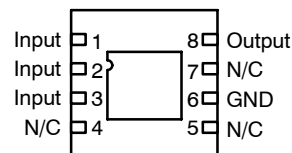


MC33275DT



Pins 4 and 5 Not Connected

MC33275D



MC33275MN

## MAXIMUM RATINGS

| Rating  | Symbol          | Value              | Unit               |
|---|-----------------|--------------------|--------------------|
| Input Voltage   | $V_{CC}$        | 13                 | Vdc                |
| Power Dissipation and Thermal Characteristics<br>$T_A = 25^\circ\text{C}$ |                 |                    |                    |
| Maximum Power Dissipation   | $P_D$           | Internally Limited | W                  |
| Case 751 (SOIC-8) D Suffix  |                 |                    |                    |
| Thermal Resistance, Junction-to-Ambient                                   | $R_{\theta JA}$ | 160                | $^\circ\text{C/W}$ |
| Thermal Resistance, Junction-to-Case                                      | $R_{\theta JC}$ | 25                 | $^\circ\text{C/W}$ |
| Case 318E (SOT-223) ST Suffix   |                 |                    |                    |
| Thermal Resistance, Junction-to-Air                                       | $R_{\theta JA}$ | 245                | $^\circ\text{C/W}$ |
| Thermal Resistance, Junction-to-Case                                      | $R_{\theta JC}$ | 15                 | $^\circ\text{C/W}$ |
| Case 369A (DPAK-3) DT Suffix  |                 |                    |                    |
| Thermal Resistance, Junction-to-Air                                       | $R_{\theta JA}$ | 92                 | $^\circ\text{C/W}$ |
| Thermal Resistance, Junction-to-Case                                      | $R_{\theta JC}$ | 6.0                | $^\circ\text{C/W}$ |
| Case 488AF (DFN-8, 4x4) MN Suffix   |                 |                    |                    |
| Thermal Resistance, Junction-to-Air (with 1.0 oz PCB cu area)             | $R_{\theta JA}$ | 183                | $^\circ\text{C/W}$ |
| Thermal Resistance, Junction-to-Air (with 1.8 oz PCB cu area)             | $R_{\theta JA}$ | 93                 | $^\circ\text{C/W}$ |
| Thermal Resistance, Junction-to-Case                                      | psi-JC*         | 9.0                | $^\circ\text{C/W}$ |
| Output Current  | $I_O$           | 300                | mA                 |
| Maximum Junction Temperature  | $T_J$           | 150                | $^\circ\text{C}$   |
| Operating Ambient Temperature Range                                       | $T_A$           | - 40 to +125       | $^\circ\text{C}$   |
| Storage Temperature Range   | $T_{stg}$       | - 65 to +150       | $^\circ\text{C}$   |
| Electrostatic Discharge Sensitivity (ESD)                                 | ESD             |                    | V                  |
| Human Body Model (HBM)  |                 | 4000               |                    |
| Machine Model (MM)  |                 | 400                |                    |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

\*"C" ("case") is defined as the solder-attach interface between the center of the exposed pad on the bottom of the package, and the board to which it is attached.

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## ELECTRICAL CHARACTERISTICS ( $C_L = 1.0\mu\text{F}$ , $T_A = 25^\circ\text{C}$ , for min/max values $T_J = -40^\circ\text{C}$ to $+125^\circ\text{C}$ , Note 1)

| Characteristic  | Symbol              | Min  | Typ  | Max   | Unit                |
|---|---------------------|--|--|---|---------------------|
| Output Voltage<br>$I_O = 0 \text{ mA to } 250 \text{ mA}$<br>2.5 V Suffix $T_A = 25^\circ\text{C}$ , $V_{in} = [V_O + 1] \text{ V}$<br>3.0 V Suffix<br>3.3 V Suffix<br>5.0 V Suffix<br><br>2.5 V Suffix $V_{in} = [V_O + 1] \text{ V}$ , $0 < I_O < 100 \text{ mA}$<br>3.0 V Suffix 2% Tolerance from $T_J = -40$ to $+125^\circ\text{C}$<br>3.3 V Suffix<br>5.0 V Suffix | $V_O$               | 2.475<br>2.970<br>3.267<br>4.950<br><br>2.450<br>2.940<br>3.234<br>4.900 | 2.50<br>3.00<br>3.30<br>5.00<br><br>–<br>–<br>–<br>– | 2.525<br>3.030<br>3.333<br>5.05<br><br>2.550<br>3.060<br>3.366<br>5.100 | Vdc                 |
| Line Regulation<br>$V_{in} = [V_O + 1] \text{ V to } 12 \text{ V}$ , $I_O = 250 \text{ mA}$ ,<br>All Suffixes $T_A = 25^\circ\text{C}$  | $\text{Reg}_{line}$ | –  | 2.0  | 10  | mV                  |
| Load Regulation<br>$V_{in} = [V_O + 1] \text{ V}$ , $I_O = 0 \text{ mA to } 250 \text{ mA}$ ,<br>All Suffixes $T_A = 25^\circ\text{C}$  | $\text{Reg}_{load}$ | –  | 5.0  | 25  | mV                  |
| Dropout Voltage<br>$I_O = 10 \text{ mA}$ $T_J = -40^\circ\text{C to } +125^\circ\text{C}$<br>$I_O = 100 \text{ mA}$<br>$I_O = 250 \text{ mA}$<br>$I_O = 300 \text{ mA}$   | $V_{in} - V_O$      | –<br>–<br>–<br>–   | 25<br>115<br>220<br>260                              | 100<br>200<br>400<br>500  | mV                  |
| Ripple Rejection (120 Hz) $V_{in(\text{peak-peak})} = [V_O + 1.5] \text{ V to } [V_O + 5.5] \text{ V}$  | –                   | 65   | 75   | –   | dB                  |
| Output Noise Voltage<br>$C_L = 1.0 \mu\text{F}$ $I_O = 50 \text{ mA}$ (10 Hz to 100 kHz)<br>$C_L = 200 \mu\text{F}$   | $V_n$               | –<br>–   | 160<br>46  | –<br>–  | $\mu\text{V}_{rms}$ |

## CURRENT PARAMETERS

|   |             |                  |                              |                              |               |
|---|-------------|------------------|------------------------------|------------------------------|---------------|
| Quiescent Current ON Mode<br>$V_{in} = [V_O + 1] \text{ V}$ , $I_O = 0 \text{ mA}$  | $I_{QON}$   | –                | 125                          | 200                          | $\mu\text{A}$ |
| Quiescent Current ON Mode SAT<br>$V_{in} = [V_O - 0.5] \text{ V}$ , $I_O = 0 \text{ mA}$ (Note 2)<br>2.5 V Suffix<br>3.0 V Suffix<br>3.3 V Suffix<br>5.0 V Suffix | $I_{QSAT}$  | –<br>–<br>–<br>– | 1100<br>1500<br>1500<br>1500 | 1500<br>2000<br>2000<br>2000 | $\mu\text{A}$ |
| Current Limit<br>$V_{in} = [V_O + 1] \text{ V}$ , $V_O$ Shorted   | $I_{LIMIT}$ | –                | 450                          | –                            | mA            |

## THERMAL SHUTDOWN

|                  |   |   |     |   |                  |
|------------------|---|---|-----|---|------------------|
| Thermal Shutdown | – | – | 150 | – | $^\circ\text{C}$ |
|------------------|---|---|-----|---|------------------|

1. Low duty pulse techniques are used during test to maintain junction temperature as close to ambient as possible.
2. Quiescent Current is measured where the PNP pass transistor is in saturation.  $V_{in} = [V_O - 0.5] \text{ V}$  guarantees this condition.

## DEFINITIONS

**Load Regulation** – The change in output voltage for a change in load current at constant chip temperature.

**Dropout Voltage** – The input/output differential at which the regulator output no longer maintains regulation against further reductions in input voltage. Measured when the output drops 100 mV below its nominal value (which is measured at 1.0 V differential), dropout voltage is affected by junction temperature, load current and minimum input supply requirements.

**Output Noise Voltage** – The RMS AC voltage at the output with a constant load and no input ripple, measured over a specified frequency range.

**Maximum Power Dissipation** – The maximum total dissipation for which the regulator will operate within specifications.

**Quiescent Current** – Current which is used to operate the regulator chip and is not delivered to the load.

**Line Regulation** – The change in output voltage for a change in the input voltage. The measurement is made under conditions of low dissipation or by using pulse techniques such that the average chip temperature is not significantly affected.

**Maximum Package Power Dissipation** – The maximum package power dissipation is the power dissipation level at which the junction temperature reaches its maximum value i.e. 150°C. The junction temperature is rising while the

difference between the input power ( $V_{CC} \times I_{CC}$ ) and the output power ( $V_{out} \times I_{out}$ ) is increasing.

Depending on ambient temperature, it is possible to calculate the maximum power dissipation and so the maximum current as following:

$$P_d = \frac{T_J \Delta T_A}{R_{\theta JA}}$$

The maximum operating junction temperature  $T_J$  is specified at 150°C, if  $T_A = 25^\circ\text{C}$ , then  $P_D$  can be found. By neglecting the quiescent current, the maximum power dissipation can be expressed as:

$$I_{out} = \frac{P_D}{V_{CC} \Delta V_{out}}$$

The thermal resistance of the whole circuit can be evaluated by deliberately activating the thermal shutdown of the circuit (by increasing the output current or raising the input voltage for example).

Then you can calculate the power dissipation by subtracting the output power from the input power. All variables are then well known: power dissipation, thermal shutdown temperature and ambient temperature.

$$R_{\theta JA} = \frac{T_J \Delta T_A}{P_D}$$

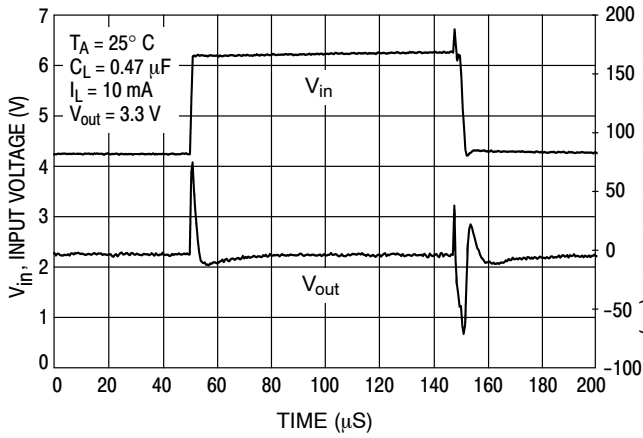


Figure 2. Line Transient Response

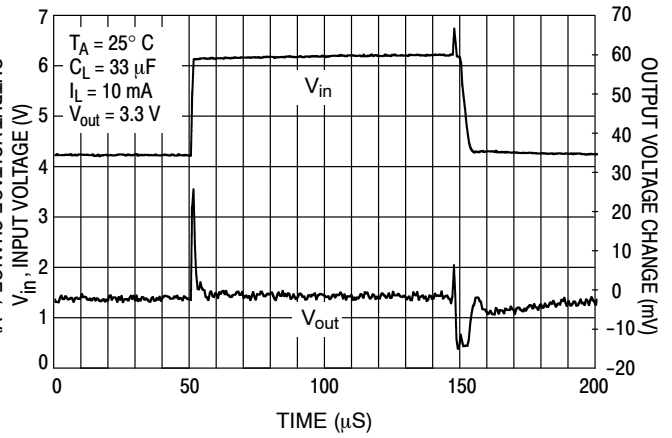


Figure 3. Line Transient Response

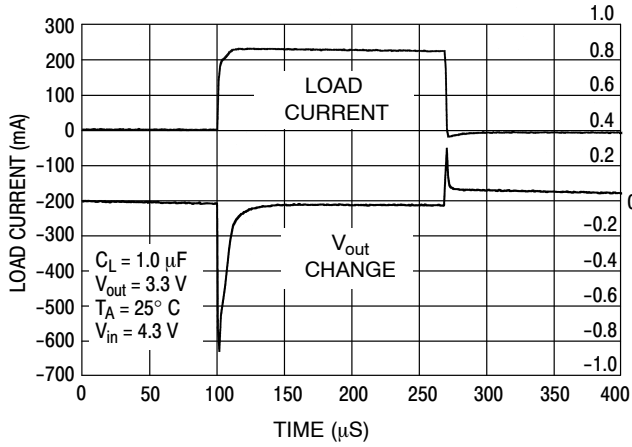


Figure 4. Load Transient Response

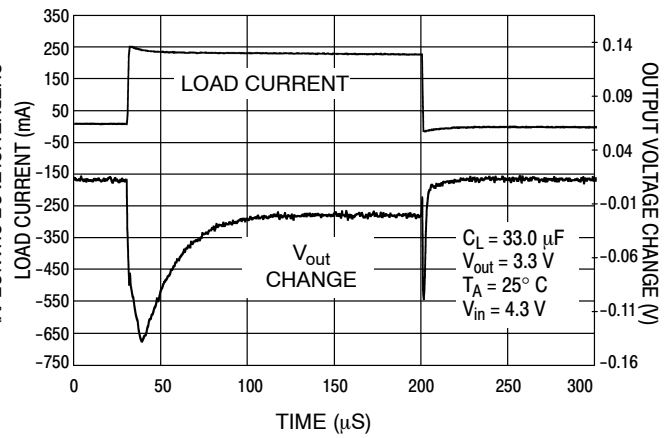


Figure 5. Load Transient Response

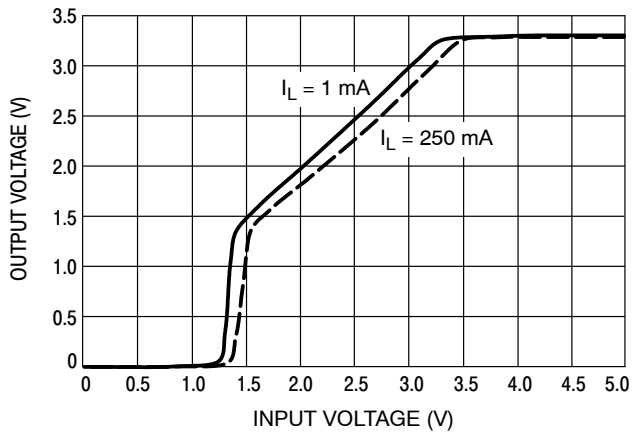


Figure 6. Output Voltage versus Input Voltage

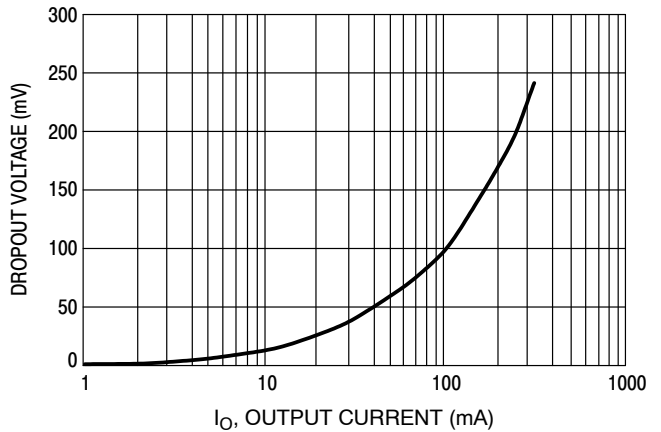


Figure 7. Dropout Voltage versus Output Current

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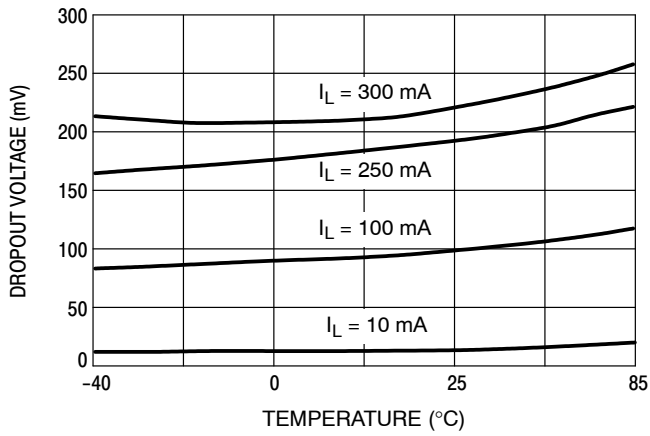


Figure 8. Dropout Voltage versus Temperature

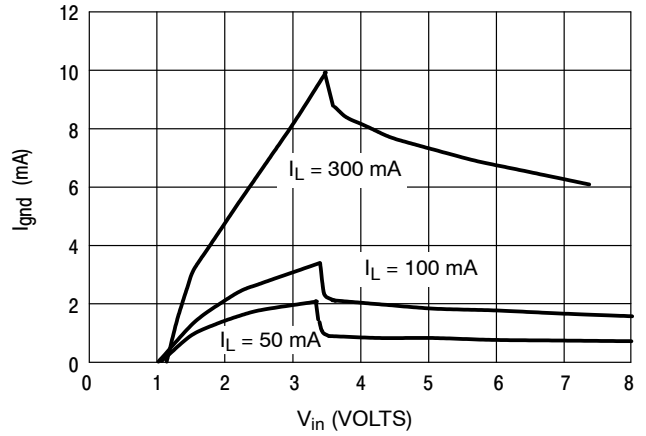


Figure 9. Ground Pin Current versus Input Voltage

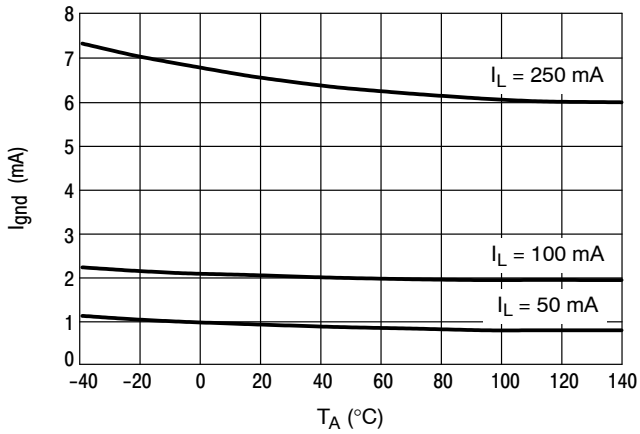


Figure 10. Ground Pin Current versus Ambient Temperature

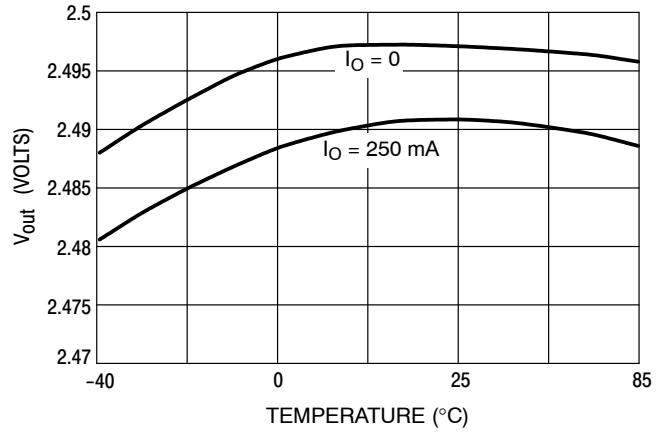
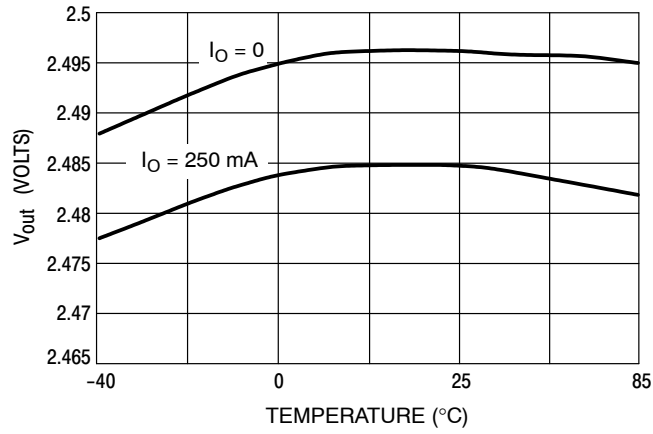
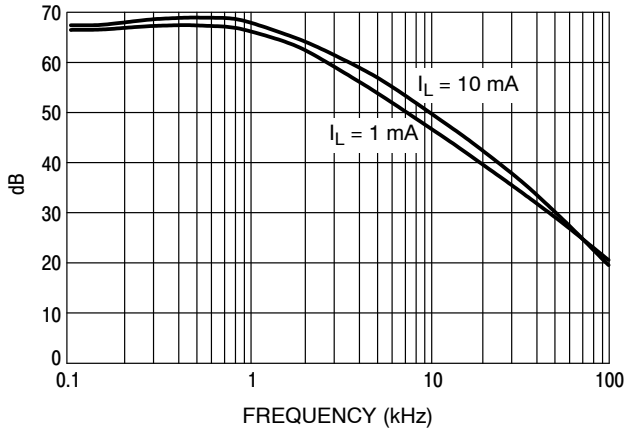


Figure 11. Output Voltage versus Ambient Temperature ( $V_{in} = V_{out} + 1V$ )

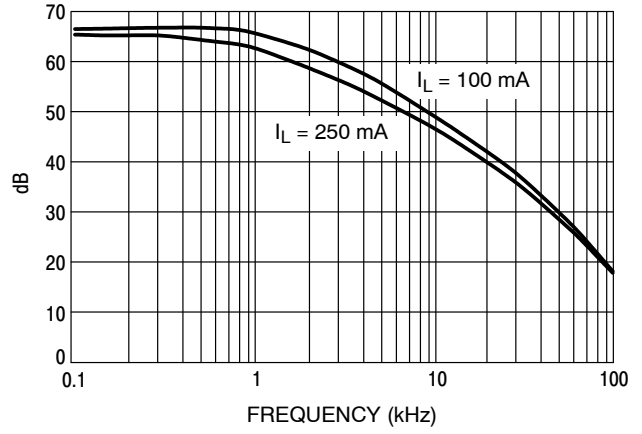
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**Figure 12. Output Voltage versus Ambient Temperature ( $V_{in} = 12\text{ V}$ )**



**Figure 13. Ripple Rejection**



**Figure 14. Ripple Rejection**

## APPLICATIONS INFORMATION

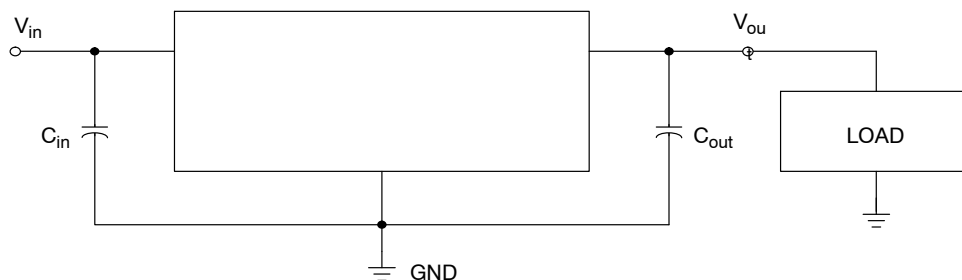
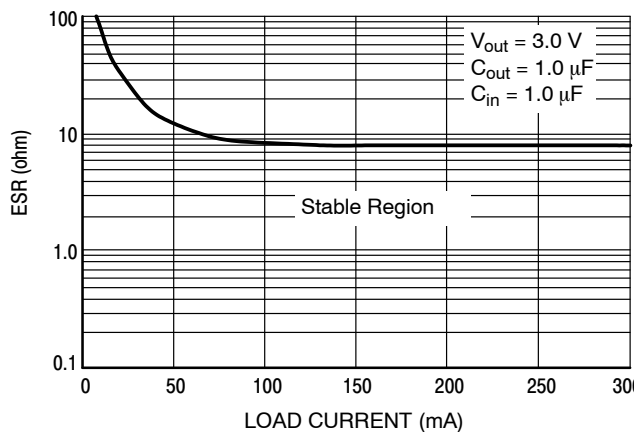


Figure 15. Typical Application Circuit

The MC33275 regulators are designed with internal current limiting and thermal shutdown making them user-friendly. Figure 15 is a typical application circuit. The output capability of the regulator is in excess of 300 mA, with a typical dropout voltage of less than 260 mV. Internal protective features include current and thermal limiting.

**EXTERNAL CAPACITORS**

These regulators require only a 0.33  $\mu\text{F}$  (or greater) capacitance between the output and ground for stability for 1.8 V, 2.5 V, 3.0 V, and 3.3 V output voltage options. Output voltage options of 5.0 V require only 0.22  $\mu\text{F}$  for stability. The output capacitor must be mounted as close as possible to the MC33275. If the output capacitor must be mounted further than two centimeters away, then a larger value of output capacitor may be required for stability. A value of 0.68  $\mu\text{F}$  or larger is recommended. Most type of aluminum, tantalum, or multilayer ceramic will perform adequately. Solid tantalums or appropriate multilayer ceramic capacitors are recommended for operation below 25°C. An input bypass capacitor is recommended to improve transient response or if the regulator is connected to the supply input filter with long wire lengths, more than 4 inches. This will reduce the circuit's sensitivity to the input line impedance at high frequencies. A 0.33  $\mu\text{F}$  or larger tantalum, mylar, ceramic, or other capacitor having low internal impedance at high frequencies should be chosen. The bypass capacitor should be mounted with shortest possible lead or track length directly across the regulator's input terminals. Figure 16 shows the ESR that allows the LDO to remain stable for various load currents.

Figure 16. ESR for  $V_{out} = 3.0\text{V}$ 

Applications should be tested over all operating conditions to insure stability.

**THERMAL PROTECTION**

Internal thermal limiting circuitry is provided to protect the integrated circuit in the event that the maximum junction temperature is exceeded. When activated, typically at 150°C, the output is disabled. There is no hysteresis built into the thermal protection. As a result the output will appear to be oscillating during thermal limit. The output will turn off until the temperature drops below the 150°C then the output turns on again. The process will repeat if the junction increases above the threshold. This will continue until the existing conditions allow the junction to operate below the temperature threshold.

**Thermal limit is not a substitute for proper heatsinking.**

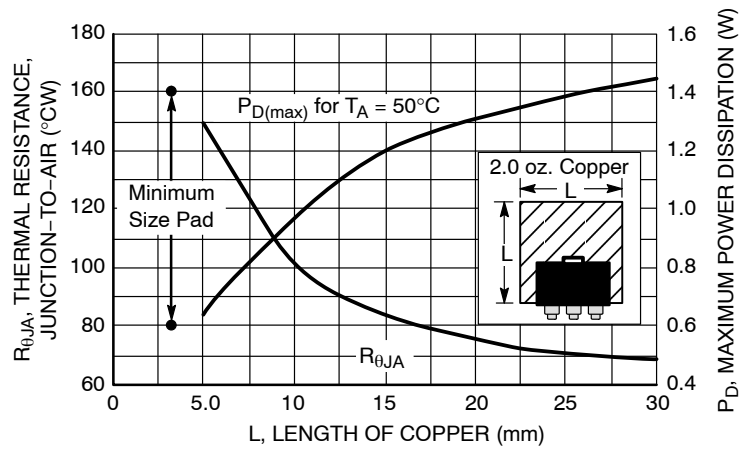
The internal current limit will typically limit current to 450 mA. If during current limit the junction exceeds 150°C, the thermal protection will protect the device also. **Current limit is not a substitute for proper heatsinking.**

**OUTPUT NOISE**

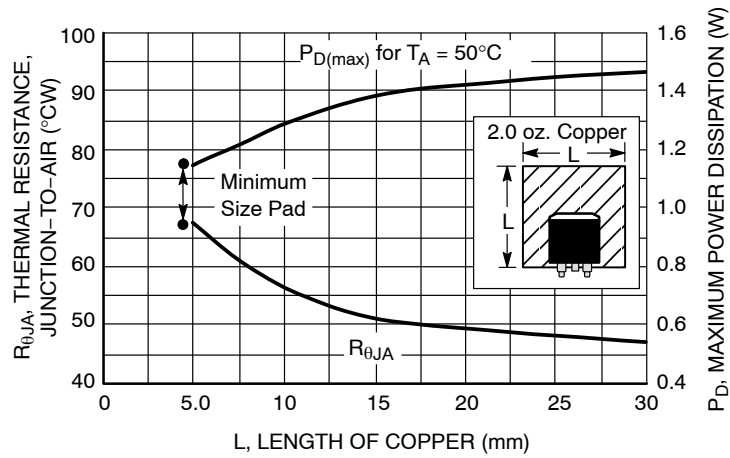
In many applications it is desirable to reduce the noise present at the output. Reducing the regulator bandwidth by increasing the size of the output capacitor will reduce the noise.



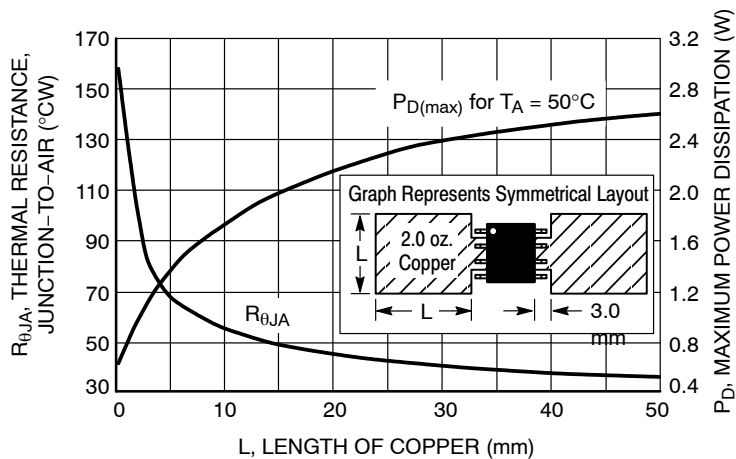
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**Figure 17. SOT-223 Thermal Resistance and Maximum Power Dissipation versus P.C.B. Copper Length**



**Figure 18. DPAK Thermal Resistance and Maximum Power Dissipation versus P.C.B. Copper Length**



**Figure 19. SOP-8 Thermal Resistance and Maximum Power Dissipation versus P.C.B. Copper Length**

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## ORDERING INFORMATION

| Device           | V <sub>O</sub> Typ (V)   | Operating Temperature Range, Tolerance                 | Case  | Package              | Marking | Shipping <sup>†</sup> |
|------------------|--------------------------|--|-------|----------------------|---------|-----------------------|
| MC33275D-2.5     | 2.5 V<br>(Fixed Voltage) | 1% Tolerance<br>at T <sub>A</sub> = 25°C               | 751   | SOIC-8               | 27525   | 98 Units/Rail         |
| MC33275D-2.5G    |                          |  | 751   | SOIC-8<br>(Pb-Free)  | 27525   | 98 Units/Rail         |
| MC33275D-2.5R2   |                          |  | 751   | SOIC-8               | 27525   | 2500/Tape & Reel      |
| MC33275D-2.5R2G  |                          |  | 751   | SOIC-8<br>(Pb-Free)  | 27525   | 2500/Tape & Reel      |
| MC33275DT-2.5    |                          |  | 369A  | DPAK                 | 27525   | 75 Units/Rail         |
| MC33275DT-2.5G   |                          |  | 369A  | DPAK<br>(Pb-Free)    | 27525G  | 75 Units/Rail         |
| MC33275DT-2.5RK  |                          |  | 369A  | DPAK                 | 27525   | 2500/Tape & Reel      |
| MC33275DT-2.5RKG |                          |  | 369A  | DPAK<br>(Pb-Free)    | 27525G  | 2500/Tape & Reel      |
| MC33275MN-2.5R2G |                          |  | 488AF | DFN8<br>(Pb-Free)    | 27525   | 3000/Tape & Reel      |
| MC33275ST-2.5T3  |                          |  | 318E  | SOT-223              | 27525   | 4000/Tape & Reel      |
| MC33275ST-2.5T3G |                          |  | 318E  | SOT-223<br>(Pb-Free) | 27525   | 4000/Tape & Reel      |
| MC33275D-3.0     | 3.0 V<br>(Fixed Voltage) | 2% Tolerance at<br>T <sub>J</sub> from -40°C to +125°C | 751   | SOIC-8               | 27530   | 98 Units/Rail         |
| MC33275D-3.0G    |                          |  | 751   | SOIC-8<br>(Pb-Free)  | 27530   | 98 Units/Rail         |
| MC33275D-3.0R2   |                          |  | 751   | SOIC-8               | 27530   | 2500/Tape & Reel      |
| MC33275D-3.0R2G  |                          |  | 751   | SOIC-8<br>(Pb-Free)  | 27530   | 2500/Tape & Reel      |
| MC33275DT-3.0    |                          |  | 369A  | DPAK                 | 27530   | 75 Units/Rail         |
| MC33275DT-3.0G   |                          |  | 369A  | DPAK<br>(Pb-Free)    | 27530G  | 75 Units/Rail         |
| MC33275DT-3.0RK  |                          |  | 369A  | DPAK                 | 27530   | 2500/Tape & Reel      |
| MC33275DT-3.0RKG |                          |  | 369A  | DPAK<br>(Pb-Free)    | 27530G  | 2500/Tape & Reel      |
| MC33275MN-3.0R2G |                          |  | 488AF | DFN8<br>(Pb-Free)    | 27530   | 3000/Tape & Reel      |
| MC33275ST-3.0T3  |                          |  | 318E  | SOT-223              | 27530   | 4000/Tape & Reel      |
| MC33275ST-3.0T3G |                          |  | 318E  | SOT-223<br>(Pb-Free) | 27530   | 4000/Tape & Reel      |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## MC33275, NCV33275

### ORDERING INFORMATION (continued)

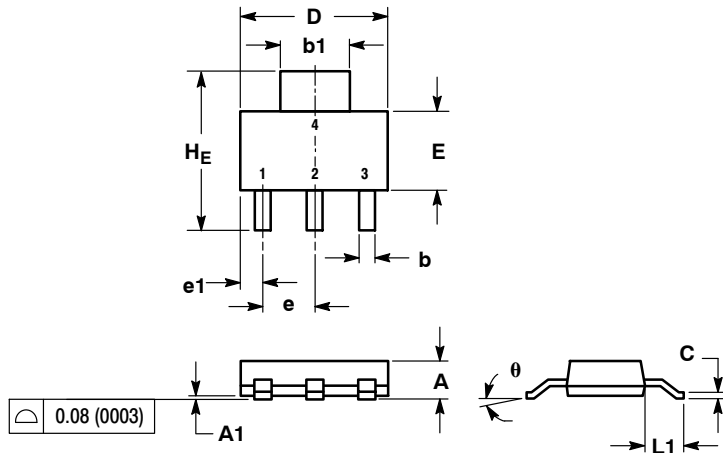
| Device            | V <sub>O</sub> Typ (V)   | Operating Temperature Range, Tolerance   | Case                     | Package                               | Marking             | Shipping <sup>†</sup> |               |
|-------------------|--|--|--------------------------|---------------------------------------|---------------------|-----------------------|---------------|
| MC33275D-3.3      | 3.3 V<br>(Fixed Voltage)   | 1% Tolerance at T <sub>A</sub> = 25°C  | 751                      | SOIC-8                                | 27533               | 98 Units/Rail         |               |
| MC33275D-3.3G     |  |  | 751                      | SOIC-8<br>(Pb-Free)                   | 27533               | 98 Units/Rail         |               |
| MC33275D-3.3R2    |  |  | 751                      | SOIC-8                                | 27533               | 2500/Tape & Reel      |               |
| MC33275D-3.3R2G   |  |  | 751                      | SOIC-8<br>(Pb-Free)                   | 27533               | 2500/Tape & Reel      |               |
| MC33275DT-3.3     |  |  | 369A                     | DPAK                                  | 27533               | 75 Units/Rail         |               |
| MC33275DT-3.3G    |  |  | 369A                     | DPAK<br>(Pb-Free)                     | 27533G              | 75 Units/Rail         |               |
| MC33275DT-3.3RK   |  | 369A   | DPAK                     | 27533                                 | 2500/Tape & Reel    |                       |               |
| MC33275DT-3.3RKG  |  | 369A   | DPAK<br>(Pb-Free)        | 27533G                                | 2500/Tape & Reel    |                       |               |
| MC33275ST-3.3T3   |  | 2% Tolerance at T <sub>J</sub> from -40°C to +125°C<br>1% Tolerance at T <sub>A</sub> = 25°C | 318E                     | SOT-223                               | 27533               | 4000/Tape & Reel      |               |
| MC33275ST-3.3T3G  |  |  | 318E                     | SOT-223<br>(Pb-Free)                  | 27533               | 4000/Tape & Reel      |               |
| NCV33275ST3.3T3G  |  |  | 318E                     | SOT-223<br>(Pb-Free)                  | 27533               | 4000/Tape & Reel      |               |
| MC33275MN-3.3R2G  |  |  | 488AF                    | DFN-8<br>(Pb-Free)                    | 27330               | 3000/Tape & Reel      |               |
| MC33275D-5.0      |  |  | 5.0 V<br>(Fixed Voltage) | 1% Tolerance at T <sub>A</sub> = 25°C | 751                 | SOIC-8                | 27550         |
| MC33275D-5.0G     | 751  |  |                          |                                       | SOIC-8<br>(Pb-Free) | 27550                 | 98 Units/Rail |
| MC33275D-5.0R2    | 751  | SOIC-8   |                          |                                       | 27550               | 2500/Tape & Reel      |               |
| MC33275D-5.0R2G   | 751  | SOIC-8<br>(Pb-Free)  |                          |                                       | 27550               | 2500/Tape & Reel      |               |
| MC33275DT-5.0     | 369A   | DPAK   |                          |                                       | 27550               | 75 Units/Rail         |               |
| MC33275DT-5.0G    | 369A   | DPAK<br>(Pb-Free)  |                          |                                       | 27550G              | 75 Units/Rail         |               |
| MC33275DT-5.0RK   | 369A   | DPAK   |                          | 27550                                 | 2500/Tape & Reel    |                       |               |
| MC33275DT-5.0RKG  | 369A   | DPAK<br>(Pb-Free)  |                          | 27550G                                | 2500/Tape & Reel    |                       |               |
| MC33275MN-5.0R2   | 2% Tolerance at T <sub>J</sub> from -40°C to +125°C<br>1% Tolerance at T <sub>A</sub> = 25°C | 488AF  |                          | DFN-8                                 | 27550               | 3000/Tape & Reel      |               |
| MC33275MN-5.0R2G  |  | 488AF  |                          | DFN-8<br>(Pb-Free)                    | 27550               | 3000/Tape & Reel      |               |
| MC33275ST-5.0T3   |  | 318E   |                          | SOT-223                               | 27550               | 4000/Tape & Reel      |               |
| MC33275ST-5.0T3G  |  | 318E   |                          | SOT-223<br>(Pb-Free)                  | 27550               | 4000/Tape & Reel      |               |
| NCV33275ST-5.0T3  |  | 318E   |                          | SOT-223                               | 27550               | 4000/Tape & Reel      |               |
| NCV33275ST-5.0T3G |  | 318E   |                          | SOT-223<br>(Pb-Free)                  | 27550               | 4000/Tape & Reel      |               |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# MC33275, NCV33275

## PACKAGE DIMENSIONS

SOT-223 (TO-261)  
CASE 318E-04  
ISSUE M

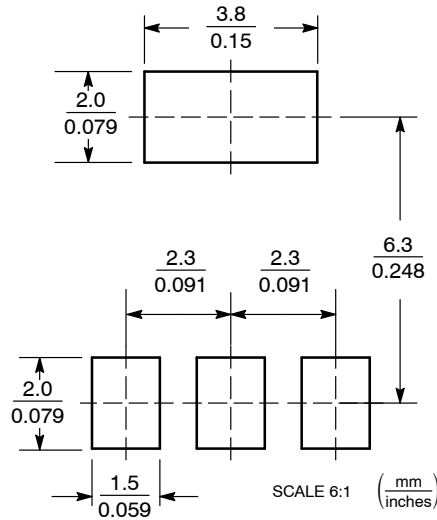


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

| DIM | MILLIMETERS |      |      | INCHES |       |       |
|-----|-------------|------|------|--------|-------|-------|
|     | MIN         | NOM  | MAX  | MIN    | NOM   | MAX   |
| A   | 1.50        | 1.63 | 1.75 | 0.060  | 0.064 | 0.068 |
| A1  | 0.02        | 0.06 | 0.10 | 0.001  | 0.002 | 0.004 |
| b   | 0.60        | 0.75 | 0.89 | 0.024  | 0.030 | 0.035 |
| b1  | 2.90        | 3.06 | 3.20 | 0.115  | 0.121 | 0.126 |
| c   | 0.24        | 0.29 | 0.35 | 0.009  | 0.012 | 0.014 |
| D   | 6.30        | 6.50 | 6.70 | 0.249  | 0.256 | 0.263 |
| E   | 3.30        | 3.50 | 3.70 | 0.130  | 0.138 | 0.145 |
| e   | 2.20        | 2.30 | 2.40 | 0.087  | 0.091 | 0.094 |
| e1  | 0.85        | 0.94 | 1.05 | 0.033  | 0.037 | 0.041 |
| L1  | 1.50        | 1.75 | 2.00 | 0.060  | 0.069 | 0.078 |
| HE  | 6.70        | 7.00 | 7.30 | 0.264  | 0.276 | 0.287 |
| θ   | 0°          | -    | 10°  | 0°     | -     | 10°   |

### SOLDERING FOOTPRINT

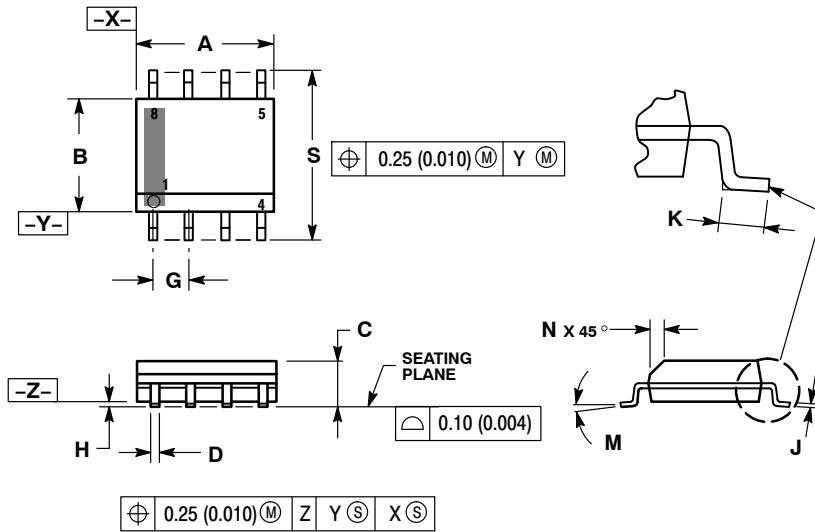


\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# MC33275, NCV33275

## PACKAGE DIMENSIONS

SOIC-8 NB  
CASE 751-07  
ISSUE AJ

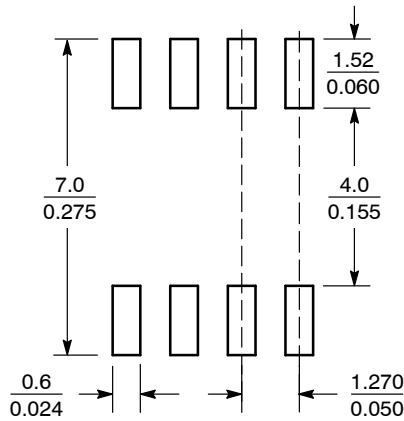


**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

| DIM | MILLIMETERS |      | INCHES    |       |
|-----|-------------|------|-----------|-------|
|     | MIN         | MAX  | MIN       | MAX   |
| A   | 4.80        | 5.00 | 0.189     | 0.197 |
| B   | 3.80        | 4.00 | 0.150     | 0.157 |
| C   | 1.35        | 1.75 | 0.053     | 0.069 |
| D   | 0.33        | 0.51 | 0.013     | 0.020 |
| G   | 1.27 BSC    |      | 0.050 BSC |       |
| H   | 0.10        | 0.25 | 0.004     | 0.010 |
| J   | 0.19        | 0.25 | 0.007     | 0.010 |
| K   | 0.40        | 1.27 | 0.016     | 0.050 |
| M   | 0° 8°       |      | 0° 8°     |       |
| N   | 0.25        | 0.50 | 0.010     | 0.020 |
| S   | 5.80        | 6.20 | 0.228     | 0.244 |

### SOLDERING FOOTPRINT\*



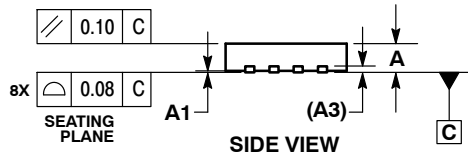
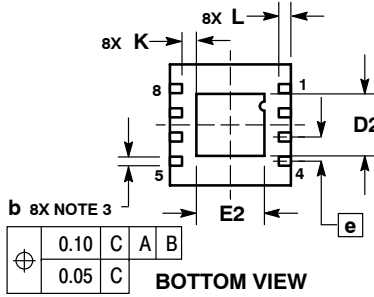
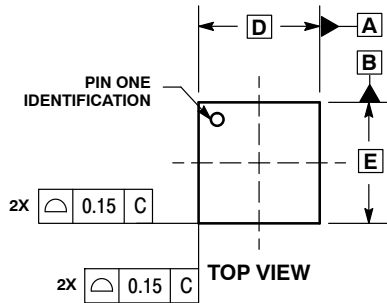
SCALE 6:1  $\left(\frac{\text{mm}}{\text{inches}}\right)$

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# MC33275, NCV33275

## PACKAGE DIMENSIONS

8 PIN DFN, 4x4  
MN SUFFIX  
CASE 488AF-01  
ISSUE B

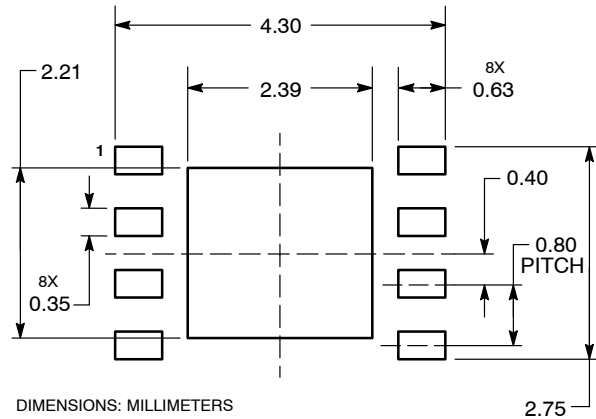


**NOTES:**

1. DIMENSIONS AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

| DIM | MILLIMETERS |      |
|-----|-------------|------|
|     | MIN         | MAX  |
| A   | 0.80        | 1.00 |
| A1  | 0.00        | 0.05 |
| A3  | 0.20        | REF  |
| b   | 0.25        | 0.35 |
| D   | 4.00        | BSC  |
| D2  | 1.91        | 2.21 |
| E   | 4.00        | BSC  |
| E2  | 2.09        | 2.39 |
| e   | 0.80        | BSC  |
| K   | 0.20        | ---  |
| L   | 0.30        | 0.50 |

### SOLDERING FOOTPRINT\*

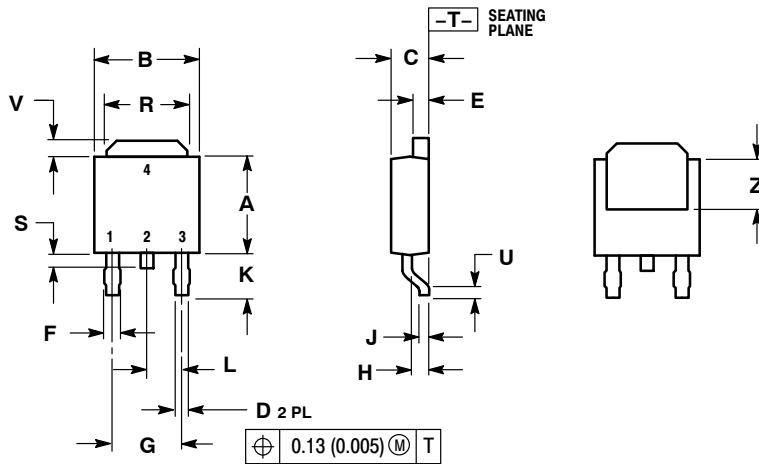


\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# MC33275, NCV33275

## PACKAGE DIMENSIONS


DPAK-3  
DT SUFFIX  
CASE 369A-13  
ISSUE AB



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

| DIM | INCHES    |       | MILLIMETERS |      |
|-----|-----------|-------|-------------|------|
|     | MIN       | MAX   | MIN         | MAX  |
| A   | 0.235     | 0.250 | 5.97        | 6.35 |
| B   | 0.250     | 0.265 | 6.35        | 6.73 |
| C   | 0.086     | 0.094 | 2.19        | 2.38 |
| D   | 0.027     | 0.035 | 0.69        | 0.88 |
| E   | 0.033     | 0.040 | 0.84        | 1.01 |
| F   | 0.037     | 0.047 | 0.94        | 1.19 |
| G   | 0.180 BSC |       | 4.58 BSC    |      |
| H   | 0.034     | 0.040 | 0.87        | 1.01 |
| J   | 0.018     | 0.023 | 0.46        | 0.58 |
| K   | 0.102     | 0.114 | 2.60        | 2.89 |
| L   | 0.090 BSC |       | 2.29 BSC    |      |
| R   | 0.175     | 0.215 | 4.45        | 5.46 |
| S   | 0.020     | 0.050 | 0.51        | 1.27 |
| U   | 0.020     | ---   | 0.51        | ---  |
| V   | 0.030     | 0.050 | 0.77        | 1.27 |
| Z   | 0.138     | ---   | 3.51        | ---  |

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